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PATENT

Docket No. <u>JCLA7294</u>

Date: / 2 -/ 0 - 2 - 1

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ASSISTANT COMMISSIONER FOR PATENTS

WASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir

Transmitted herewith for filing is the patent application of

Inventors: Nai-Shung Chang, Tsai-Sheng Chen, Shu-Hui Chen

For: CHIPSET SUPPORTING MULTIPLE CPU'S AND LAYOUT METHOD THEREOF

Enc	losed	are:

- Specification 15 pages.
- _2_ Sheets of drawings
- Recordation Form Cover sheet with 2 pages assignment.
- A certified copy of Taiwan Patent Application No. __ dated ___
 - SIGNED declaration and power of attorney.
- Return Prepaid postcard.

CLAIMS AS FILED									
FOR	NUME	ERFI	LED	NUMBE	REXTRA	RATE	FEE		
Basic Fee						\$740.00	\$740.00		
Total Claims	16		20 =	0_	×	\$18.00	\$0.00		
Independent Claims	3		3 =	. 0	×	\$84.00	\$0.00		
If application contains any multiple dependent claim (s), then add					\$280.00	\$0.00			
TOTAL FILING FEE					\$740.00				

A check in the amount of \$740.00 cover the filing fee is enclosed.

A check in the amount of \$40.00 to cover the assignment recording fee.

A duplicate copy of this sheet is enclosed.

Jiawei Huang

Registration No. 43,330

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CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Docket No. : JCLA7294

Applicant(s) : Nai-Shung Chang, Tsai-Sheng Chen, Shu-Hui

Chen

For : CHIPSET SUPPORTING MULTIPLE CPU'S

AND LAYOUT METHOD THEREOF

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I hereby certify that the accompanying

Transmittal in Duplicate; Specification _15_pages, _2_ sheets of drawings; SIGNED Declaration and Power of Attorney _2_ pages; Recordation Form Cover Sheet and Assignment _3_ pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

M. Chang
Michelle Chang